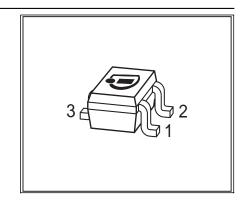


NPN Silicon RF Transistor

- For linear broadband amplifier application up to 500 MHz
- SAW filter driver in TV tuners
- Pb-free (RoHS compliant) package 1)
- Qualified according AEC Q101







Туре	Marking	Pin Configuration Package			Package
BF799W	LKs	1 = B	2 = E	3 = C	SOT323

Maximum Ratings

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V _{CEO}	20	V	
Collector-emitter voltage	V _{CES}	30		
Collector-base voltage	V _{CBO}	30		
Emitter-base voltage	V _{EBO}	3		
Collector current	l _C	35	mA	
Base current	l _B	10		
Total power dissipation	P _{tot}	280		
<i>T</i> _S = 107 °C				
Junction temperature	T _j	150	°C	
Storage temperature	$T_{ m stg}$	-65 150		

Thermal Resistance

Junction - soldering point ²⁾	R _{thJS}	≤ 155	K/W
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¹Pb-containing package may be available upon special request

²For calculation of R_{thJA} please refer to Application Note Thermal Resistance

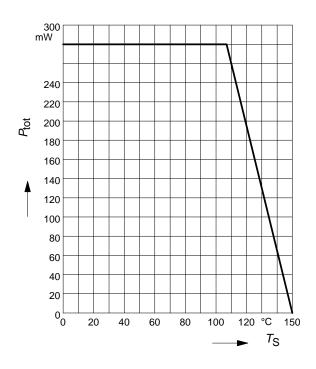


Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified.

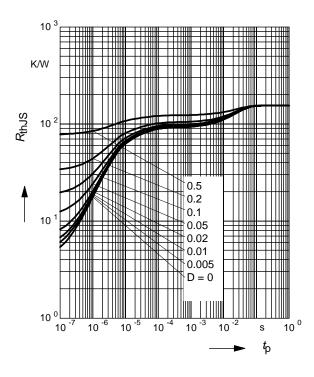
Parameter	Symbol	Values			Unit
		min.	typ.	max.	1
DC characteristics			•		•
Collector-emitter breakdown voltage	V _{(BR)CEO}	20	-	-	V
$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$					
Collector-base breakdown voltage	V _{(BR)CBO}	30	-	-	
$I_{\rm C} = 10 \ \mu {\rm A}, \ I_{\rm E} = 0$					
Base-emitter breakdown voltage	V _{(BR)EBO}	3	-	-	
$I_{\rm E} = 10 \ \mu {\rm A}, \ I_{\rm C} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\text{CB}} = 20 \text{ V}, I_{\text{E}} = 0$					
DC current gain	h _{FE}				-
$I_{\rm C} = 5 \text{ mA}, \ V_{\rm CE} = 10 \text{ V}$		35	95	-	
$I_{\rm C} = 20 \text{ mA}, \ V_{\rm CE} = 10 \text{ V}$		40	100	250	
Collector-emitter saturation voltage	V _{CEsat}	-	0.1	0.3	V
$I_{\rm C} = 20 \text{ mA}, I_{\rm B} = 2 \text{ mA}$					
Base-emitter saturation voltage	V _{BEsat}	-	-	0.95	
$I_{\rm C} = 20 \text{ mA}, I_{\rm B} = 2 \text{ mA}$					
AC characteristics	-				
Transition frequency	f _T				MHz
$I_{\rm C} = 5 \text{ mA}, \ V_{\rm CE} = 10 \text{ V}, \ f = 100 \text{ MHz}$		-	800	-	
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 8 V, f = 100 MHz		-	1100	-	
Output capacitance	C _{ob}	-	0.96	-	pF
$V_{\text{CB}} = 10 \text{ V}, I_{\text{E}} = 0 \text{ mA}, f = 1 \text{ MHz}$				<u> </u>	
Collector-base capacitance	C _{cb}	-	0.7	-	
$V_{\text{CB}} = 10 \text{ V}, f = 1 \text{ MHz}$					
Collector-emitter capacitance	C _{ce}	-	0.28	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}$					
Noise figure	F	-	3	-	dB
$I_{\rm C} = 5 \text{ mA}, \ V_{\rm CE} = 10 \text{ V}, \ f = 100 \text{ MHz},$					
$Z_{\rm S} = 50 \ \Omega$				<u> </u>	
Output conductance	g _{22e}	-	60	-	μS
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 10 V, f = 35 MHz					



Total power dissipation $P_{tot} = f(T_S)$

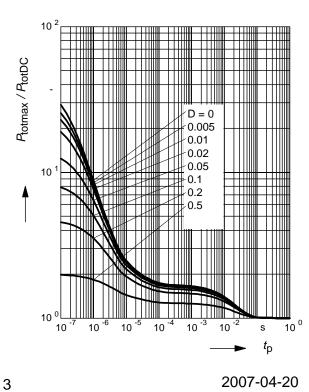


Permissible Pulse Load $R_{thJS} = f(t_p)$



Permissible Pulse Load

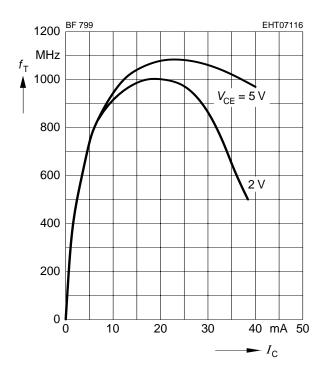
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$



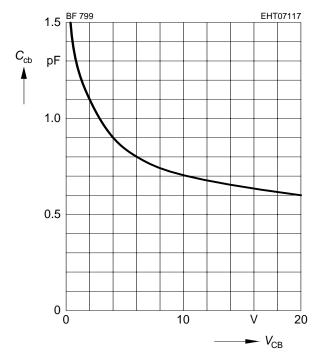


Transition frequency $f_T = f(I_C)$

f = 100MHz



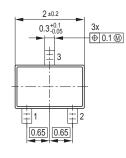
Collector-base capacitance $C_{cb} = f(V_{CB})$ f = 1 MHz

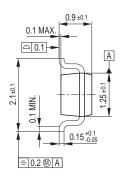




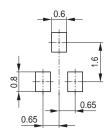
Package Outline



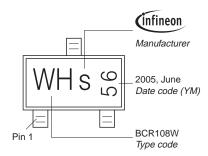




Foot Print

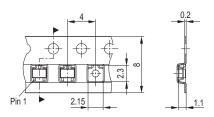


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel





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